



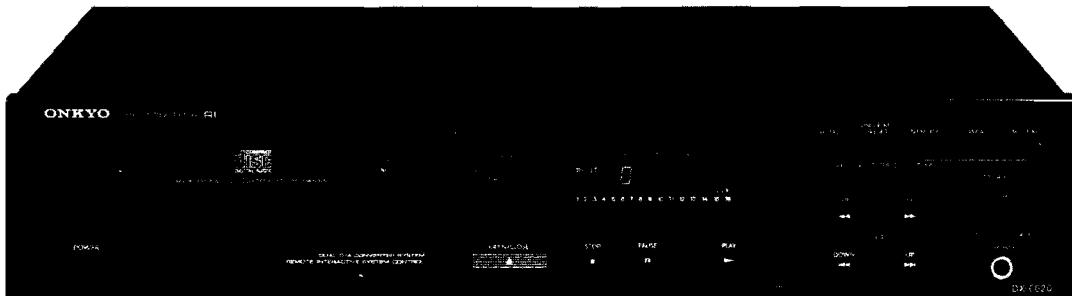
V07004

DX-6620

SERIAL NO. 3314

ONKYO® SERVICE MANUAL

COMPACT DISC PLAYER MODEL DX-6620



SAFETY-RELATED COMPONENT WARNING!!

COMPONENTS IDENTIFIED BY MARK  ON THE SCHEMATIC DIAGRAM AND IN THE PARTS LIST ARE CRITICAL FOR RISK OF FIRE AND ELECTRIC SHOCK. REPLACE THESE COMPONENTS WITH ONKYO PARTS WHOSE PARTS NUMBERS APPEAR AS SHOWN IN THIS MANUAL.

SPECIFICATIONS

Compact disc player

System	Compact disc digital audio system
Laser	Semiconductor laser ($\lambda = 780 \text{ nm}$)
Emission duration	Continuous
Laser output	Max. 0.4 mW This output is the value measured at a distance of about 1.6 mm from the objective lens surface on the Optical Pick-up Block.
Frequency response	2 Hz - 20 kHz ($\pm 0.5 \text{ dB}$)
Signal to noise ratio	More than 100 dB
Dynamic range	More than 88 dB
Harmonic distortion	Less than 0.05% (1 kHz)
Wow and flutter	Below measurable limit
Outputs	LINE OUT (phono jacks) Output level 2 V (at 50 kilohms) Load impedance over 10 kilohms
Channel separation	More than 92 dB (1 kHz)

General

Power requirements	220 V AC, 50 Hz
Power consumption	10 W
Dimensions (approx.) (w/h/d)	435x98.5x340 mm (17 $\frac{1}{8}$ x 3 $\frac{1}{8}$ x 13 $\frac{1}{8}$ inches) including projecting parts and controls
Weight (approx., net)	4.5 kg (9.9 lbs)

ONKYO
AUDIO COMPONENTS

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PROTECTION OF EYES FROM LASER BEAM DURING SERVICING

This set employs a laser. Therefore, be sure to follow carefully the instructions below when servicing.

CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

1. Laser Diode Properties

- Material: GaAlAs
- Wavelength: 780 nm
- Emission Duration: continuous
- Laser Output: max. 44.6 μ W*

* This output is the value measured at a distance of about 200 mm from the objective lens surface on the Optical Pick-up Block.

2. During service, do not take the Optical Pick-up Block apart, and do not adjust the APC circuit. If there is a breakdown in the APC circuit (including laser diode), replace the entire Optical Pick-up Block (including APC board).

BESKYTTELSE AF ØJNE MOD LASERSTRÅLING UNDER SERVICE

I dette apparat anvendes laserlys. Derfor skal nedenstående instruktioner nøje følges under service.

Følg iøvrigt instruktionerne i servicemanualen.

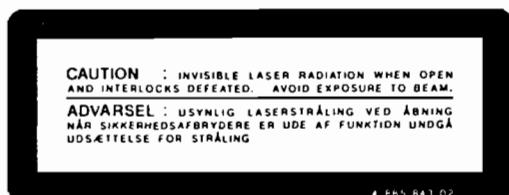
ADVARSEL!!

Under service må øjnene ikke komme nær objektiv-linsen på den optiske pick-up enhed. I tilfælde af at det er nødvendigt at kontrollere udsendelsen af laserlys, skal det ske i en afstand af mere end 25 cm fra den optiske pick-up.

LASER ADVARSEL MÆRKNING

Følgende mærkning findes indvendig i apparatet:

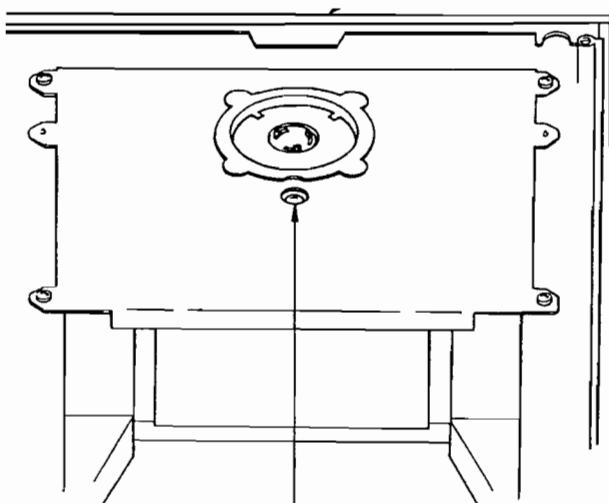
1. Advarsel Mærkning



SERVICING NOTE

LASER DIODE AND FOCUS SEARCH OPERATION CHECK

1. Make POWER switch on with no disc inserted and disc table closed.
2. Confirm that the operation indicated in Fig. C is performed while observing the objecting lens.



- ① Confirm that laser beam is spread.
- ② Up and down motion of the objective lens. (3 times)

Fig. C

1. Laser-didoe data

- Materiale: GaAlAs
- Bølgelængde: 780 nm
- Udstråling: Kontinuerlig
- Laseroutput: Max. 0.4 mW*

* Målt i 1,6 mm afstand fra overfladen af objektiv-linsen på den optiske pick-up enhed.

- Klassifikation: Klasse IIIb.

2. Adskil aldrig den optiske pick-up enhed under service, og juster ikke APC kredsløbet (Automatic Power Control). Hvis APC kredsløbet (incl. laser-dioden) bryder ned, skal hele den optiske pick-up enhed (incl. APC printkortet) udskiftes.

VAROITUS: Laite sisältää, laserdiodin, joka lähtää (näkymätöntä) silmille vaarallista lasersateilyä.

NOTES ON HANDLING THE OPTICAL PICK-UP BLOCK OR BASE UNIT

The laser diode in the optical pick-up block may suffer electrostatic breakdown because of the potential difference generated by the charged electrostatic load, etc. on clothing and the human body.

During repair, pay attention to electrostatic breakdown and also use the procedure in the printed matter which is included in the repair parts.

The flexible board is easily damaged and should be handled with care.

NOTES ON LASER DIODE EMISSION CHECK

The laser beam on this model is concentrated so as to be focused on the disc reflective surface by the objective lens in the optical pick-up block. Therefore, when checking the laser diode emission, observe more than 25 cm away from the objective lens.

CIRCUIT DESCRIPTIONS

IC101 (MSC6458-23SS) SYSTEM CONTROL MICROCOMPUTER

Table 1 Pin Functions IC101

Description of IC101 (MSC6458)

IC101 has the following functions:

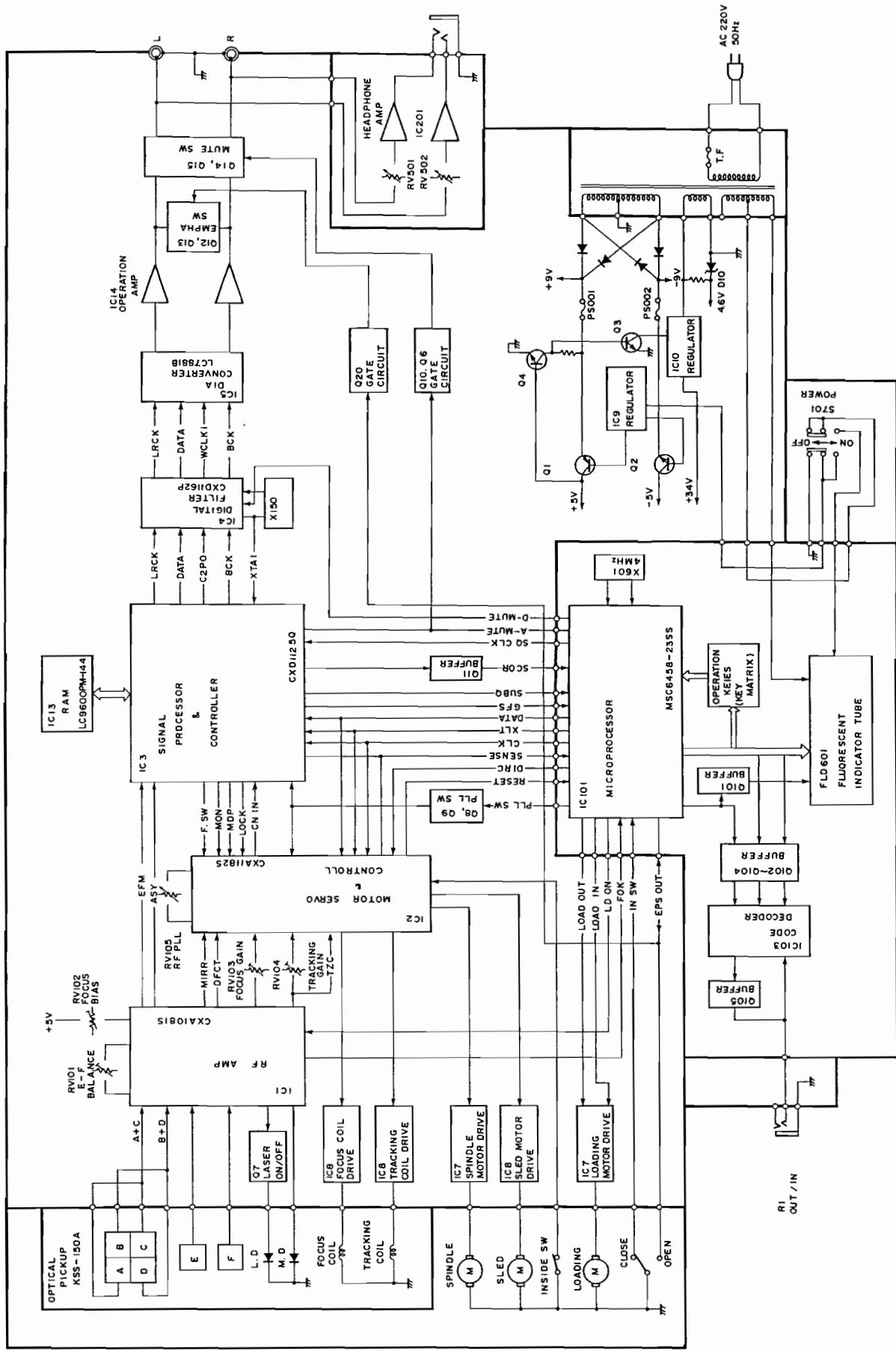
- Digital signal output to operation key
- Sub Q signal loading and processing
- Fluorescent display (FLD) control
- Servo circuit control

Pin Function

Pin No.	Pin name	I/O	Description
1	DIRC	O	Jump pulse inversion instruction during 1 track jump.
2	CLK	O	Command transfer of clock to SSP (IC2) and DSP (IC3).
3	DATA	O	Command transfer of data to SSP (IC2) and DSP (IC3).
4	XLT	O	Command transfer of latch to SSP (IC2) and DSP (IC3).
5	M-SYNC	O	Sync REC ("H" for 300msec during muting).
6	P-SYNC	O	Sync REC ("H" for 300msec when muting is off).
7	SENSE	I	SSP (IC2) and DSP (IC3) sense information.
8	SYNC ON	I	Sync REC ("L" in REC mode).
9	SIRCS	I	Remote control signal input.
10	SCOR	I	Q code read timing.
11	VL UP	O	Remote controller. "L" when volume is being increased.
12	ADJ	I	"L" in PLAY mode.
13	AMUTE	O	All muting. Output to DSP (IC3) MUTG.
14	DMUTE	O	Software muting. Output to digital filter (IC4) software.
15	SUBQ	I	Subcode data.
16	SQCLK	O	Subcode data read clock.
17	GFS	I	"H" when CLV is locked.
18	FOK	I	"H" when focus is on.
19	KEY0	I	Key matrix input, "H" active.
20	KEY1	I	Key matrix input, "H" active.
21	KEY2	I	Key matrix input, "H" active.
22	KEY3	I	Key matrix input, "H" active.
23	KEY4	I	Key matrix input, "H" active.
24	KEY5	I	Key matrix input, "H" active.
25	INSW	I	Loading IN SW.
26	LDON	O	Laser on/off.
27	EPS/OUTSW	I/O	Emphasis on/off (during loading). Loading OUT SW.
28	LODOUT	O	Loading motor control.

Pin No.	Pin name	I/O	Description
29	LODIN	O	Loading motor control.
30	OSCL	I	Oscillator input terminal (4 MHz).
31	OSCO	I	Oscillator input terminal (4 MHz).
32	GND	-	GND terminal.
33	RESET	I	Reset input terminal. Input when power is turned on.
34	TEST	-	No connection (NC).
35	VL DOWN	-	No connection (NC).
36	TIMER	-	No connection (NC).
37	AFADJ	I	"L" in PLAY mode. CLV-S is fixed. "L" in test mode before power is turned on.
38	PLLSW	O	"L" in PLAY mode and "H" in search mode.
39	8G	O	FLD timing output.
40	7G	O	FLD timing output.
41	6G	O	FLD timing output.
42	5G	O	FLD timing output.
43	4G	O	FLD timing output.
44	3G	O	FLD timing input.
45	2G	O	FLD timing input.
46	1G	O	FLD timing input.
47	NC	-	No connection (NC).
48	o	O	FLD segment output.
49	n	O	FLD segment output.
50	m	O	FLD segment output.
51	+30V	-	+30V
52	l	O	FLD segment output.
53	k	O	FLD segment output.
54	j	O	FLD segment output.
55	i	O	FLD segment output.
56	h	O	FLD segment output.
57	g	O	FLD segment output.
58	f	O	FLD segment output.
59	e	O	FLD segment output.
60	d	O	FLD segment output.
61	c	O	FLD segment output.
62	b	O	FLD segment output.
63	a	O	FLD segment output.
64	VDD	-	Positive (+) power supply (5V)

BLOCK DIAGRAM



ADJUSTMENT PROCEDURES

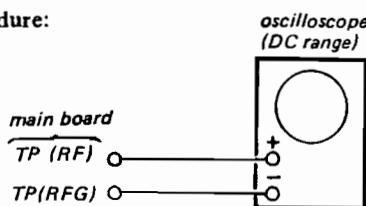
ELECTRICAL ADJUSTMENTS

1. Perform adjustments in the order given.
2. Use YEDS-18 (Part No. 0R016) disc unless otherwise indicated.
3. Use the oscilloscope with more than $10 \text{ M}\Omega$ impedance.

Focus Bias Adjustment

This adjustment should be made when replacing TOP (T-type Optical Pick-up).

Procedure:



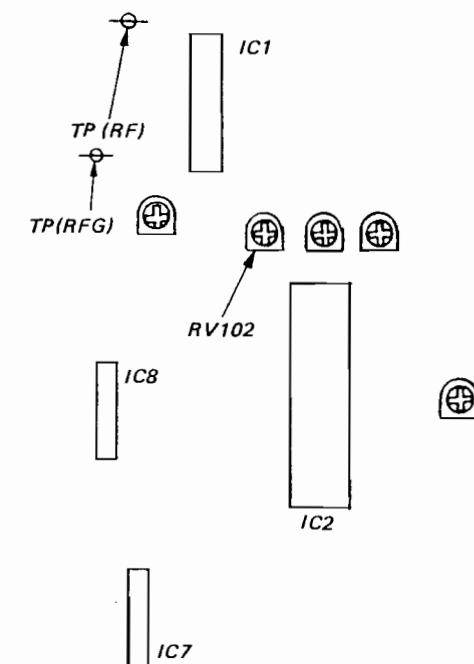
1. Connect oscilloscope to test points TP(RF).
2. Turn POWER switch on.
3. Put disc (YEDS-18) in and press ▷ button.
4. Adjust RV102 for an optimum waveform eye pattern or so that the peak is maximum. Optimum eye pattern means that shape "◇" can be clearly distinguished at the center of the waveform.

RF signal waveform



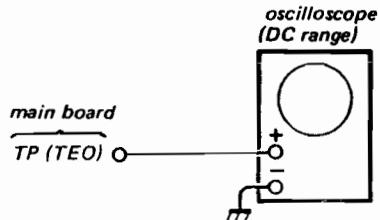
$$A = 1.2V \pm 0.2(V_{p-p})$$

Adjustment Location: main board

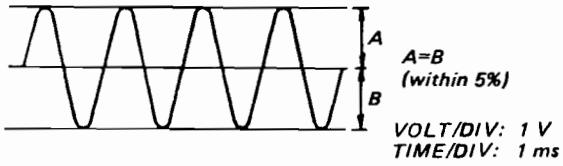
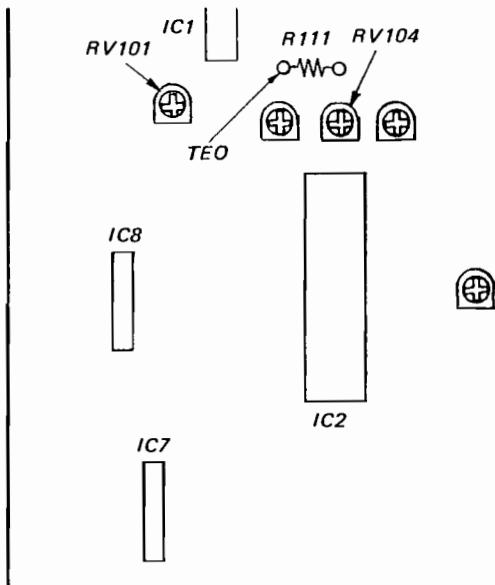
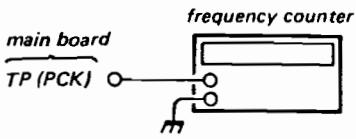


E-F Balance Adjustment

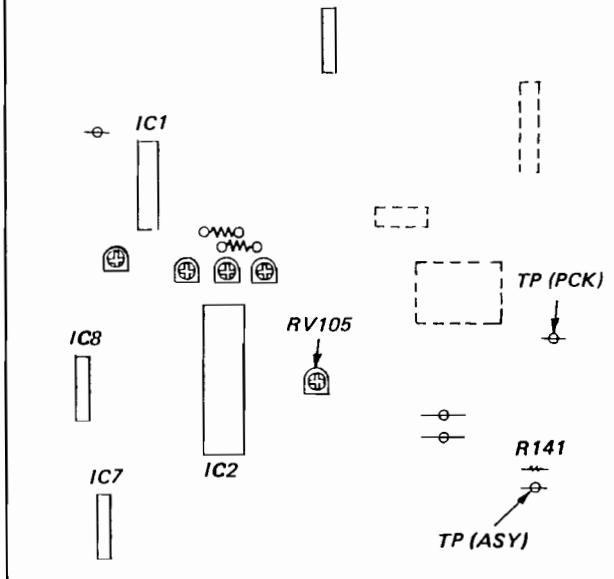
This adjustment should be made when replacing TOP (T-type Optical Pick-up).

Procedure:

1. Turn RV104 fully counterclockwise (minimum).
2. Connect oscilloscope to test point TP (TEO).
3. Turn POWER switch on.
4. Put disc (YEDS-18) in and press ▶ button.
5. Adjust RV101 so that the traverse waveform is symmetrical above and below.

**Adjustment Location:** main board**RF PLL Frequency Adjustment/Lock Frequency Check****Procedure:**

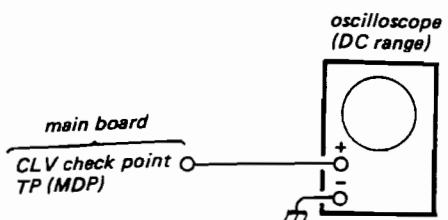
1. Connect test point TP (ASY) to ground with lead wire.
2. Turn POWER switch on.
3. Connect the frequency counter to test points TP (PCK).
4. Adjust RV105 so that the reading on frequency counter is $4.3218 \text{ MHz} \pm 30 \text{ kHz}$.
.....(RF PLL frequency adjustment)
5. Remove lead wire connecting TP (ASY) to ground.
6. Put disc (YEDS-18) in and press ▶ button.
7. Confirm that the reading on frequency counter is 4.3218 MHz.
8. After adjustment, remove the lead wire connected in step 5.

Adjustment Location: main board

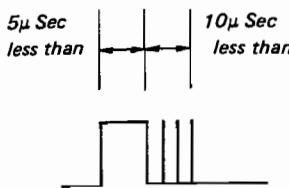
REFERENCE

CLV Phase Lock Check

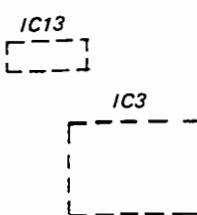
Procedure:



1. Connect oscilloscope to test point TP (MDP).
2. Turn POWER switch on.
3. Put disc (YEDS-18; TRACK No. 5) in and press ▶ button.
4. Check that the waveform is as shown in the figure below.



Adjustment Location: main board



MDP

Focus/Tracking Gain Adjustment

A frequency response analyzer is necessary in order to perform this adjustment exactly.

However, this gain has a margin, so even if it is slightly off, there is no problem. Therefore, do not perform this adjustment.

Focus/tracking gain determines the pick-up follow-up (vertical and horizontal) relative to mechanical noise and mechanical shock when the 2-axis device operate.

However, as these reciprocate, the adjustment is at the point where both are satisfied.

- When gain is raised, the noise when the 2-axis device operates increases.
- When gain is lowered, it is more susceptible to mechanical shock and skipping occurs more easily.
- When gain adjustment is off, the symptoms below appear.

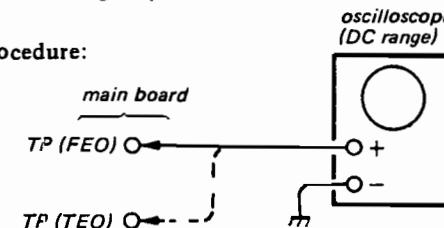
Symptoms	Gain	Focus	Tracking
● The time until music starts becomes longer for STOP → ▶PLAY or automatic selection (◀▶ buttons pressed. (Normally takes about 2 seconds.)	low	low or high	low or high
● Music does not start and disc continues to rotate for STOP → ▶PLAY or automatic selection (◀▶ buttons pressed.)	-	low	low
● Disc table opens shortly after STOP → ▶PLAY.	low or high	-	-
● Sound is interrupted during PLAY. Or time counter display stops progressing.	-	low	low
● More noise during 2-axis device operation.	high	high	high

The following is a simple adjustment method.

Simple Adjustment -

Note: Since exact adjustment cannot be performed, remember the positions of the controls before performing the adjustment. If the positions after the simple adjustment are only a little different, return the controls to the original position.

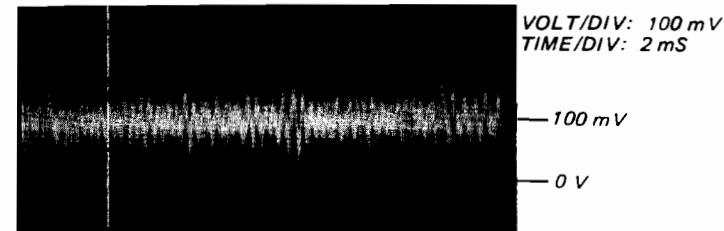
Procedure:



1. Keep the set horizontal.

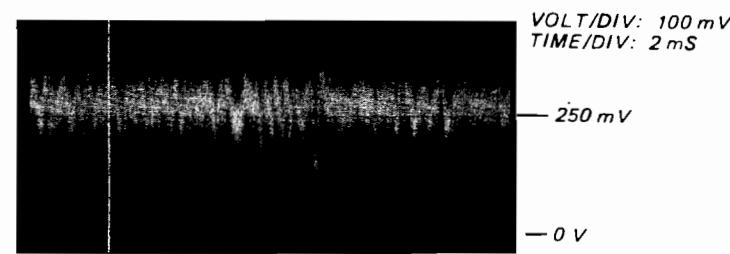
If the set is not horizontal, this adjustment cannot be performed due to the gravity against the 2 axis device.

2. Insert disc (YEDS-18) and press ▶PLAY button.
3. Connect oscilloscope to main amp board TP(FEO).
4. Adjust RV103 so that the waveform is as shown in the figure below. (focus gain adjustment)

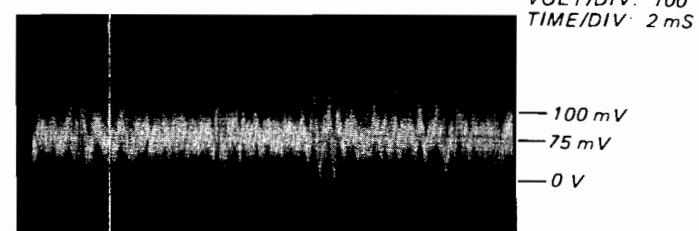


- Incorrect Examples (DC level changes more than on adjusted waveform)

low focus gain

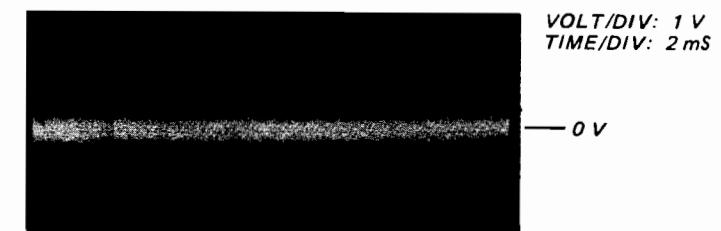


high focus gain



5. Connect oscilloscope to main board TP (TEO).

6. Adjust RV104 so that the waveform is as shown in the figure below. (tracking gain adjustment)

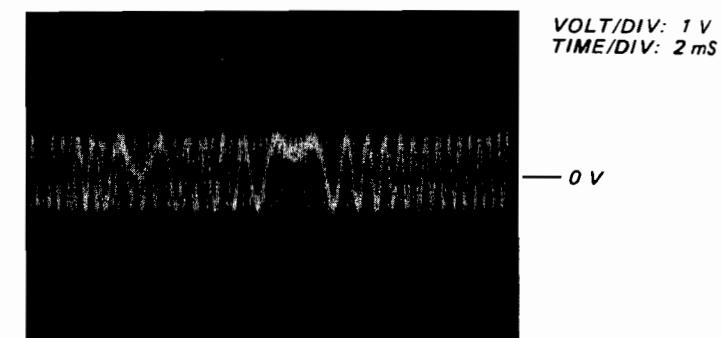


- Incorrect Examples (fundamental wave appears)

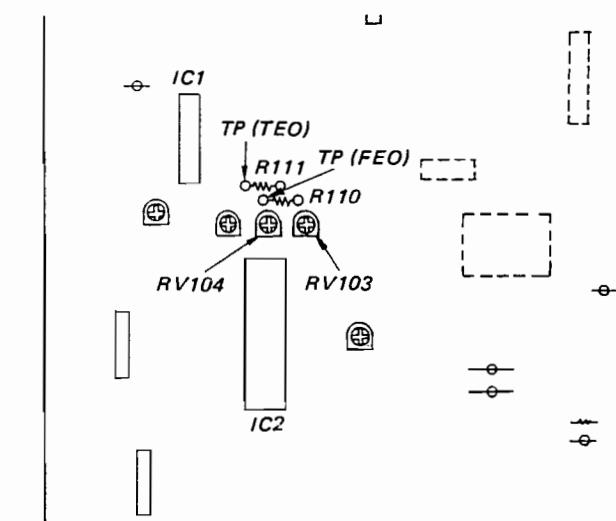
low tracking gain



high tracking gain
(higher fundamental wave than for low gain)

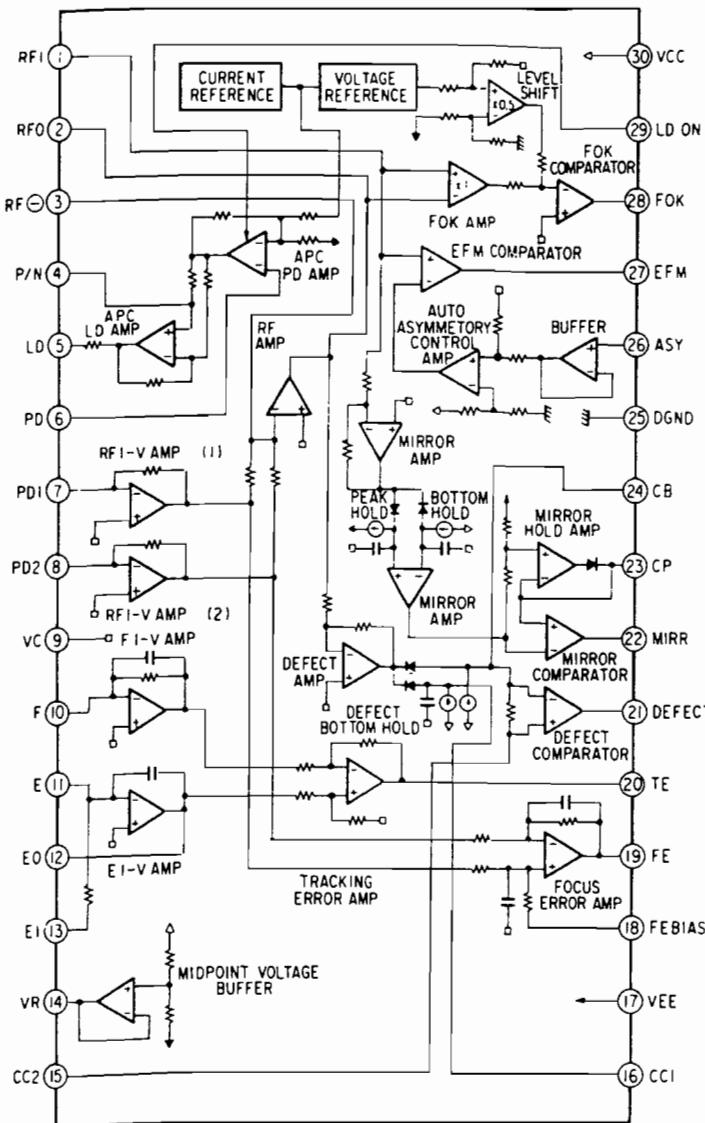


Adjustment Location: main board

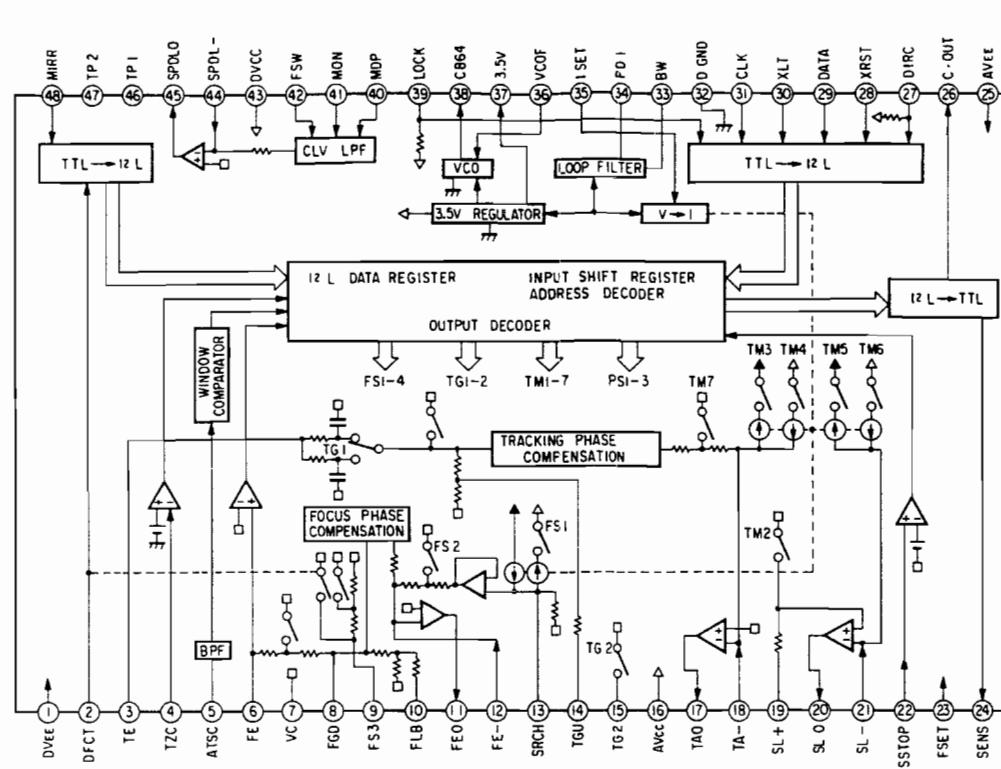


IC BLOCK DIAGRAM

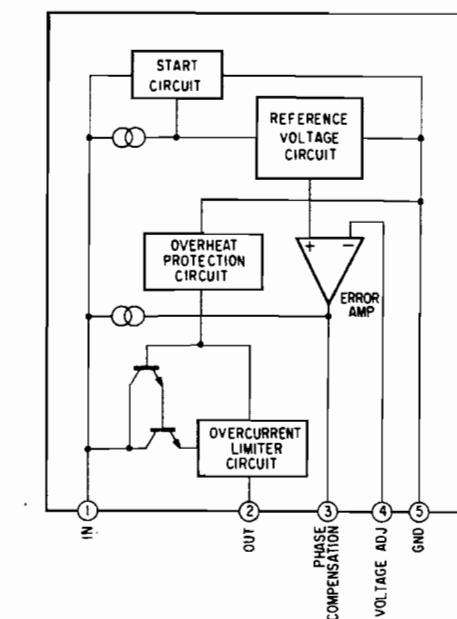
IC1 CXA1081S



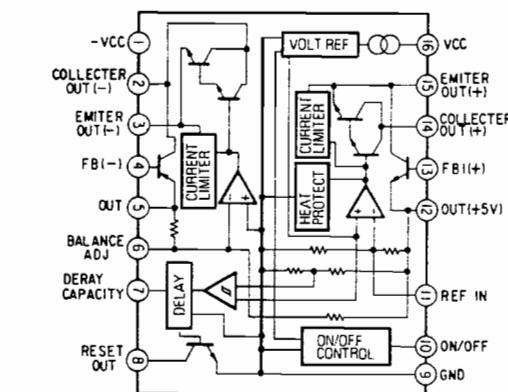
IC2 CXA1182S



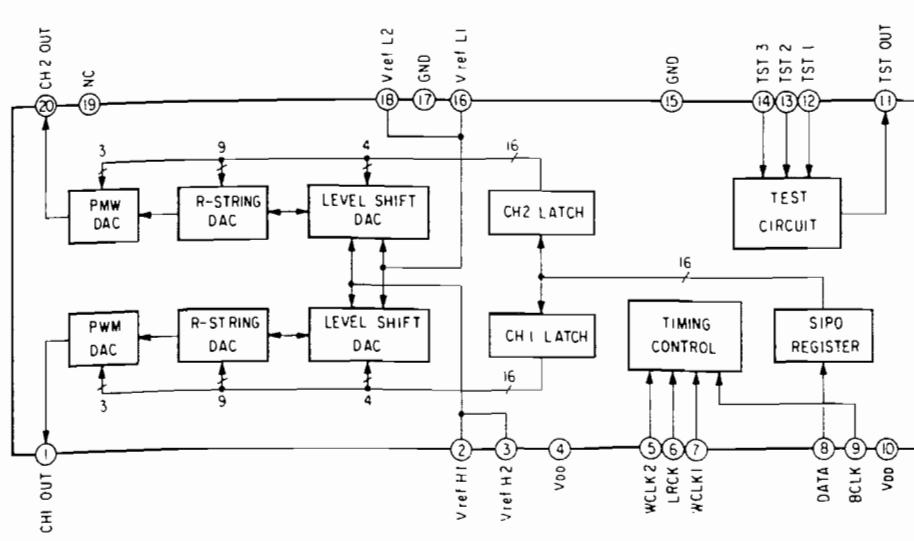
IC10 M5231TL



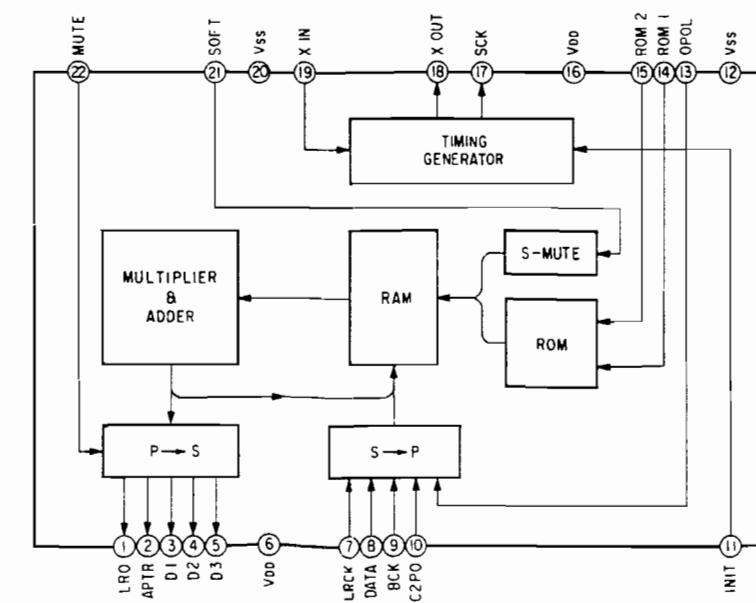
IC9 M5290-16



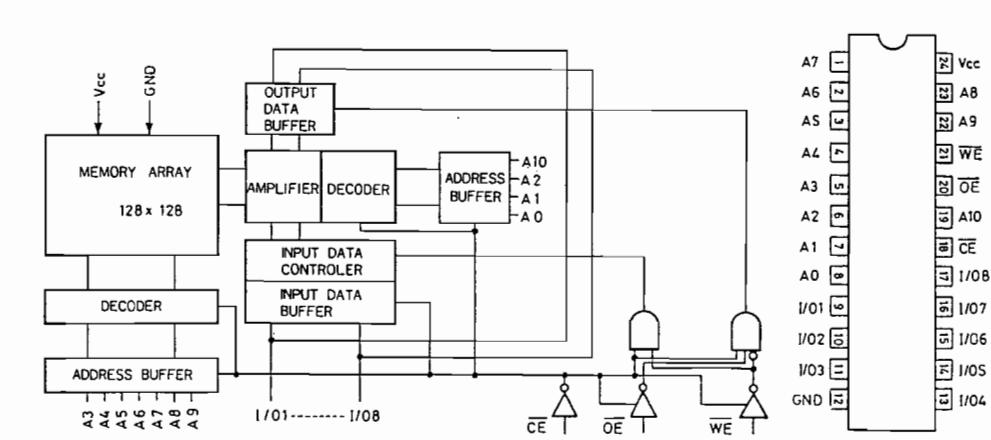
IC5 LC-7881-B



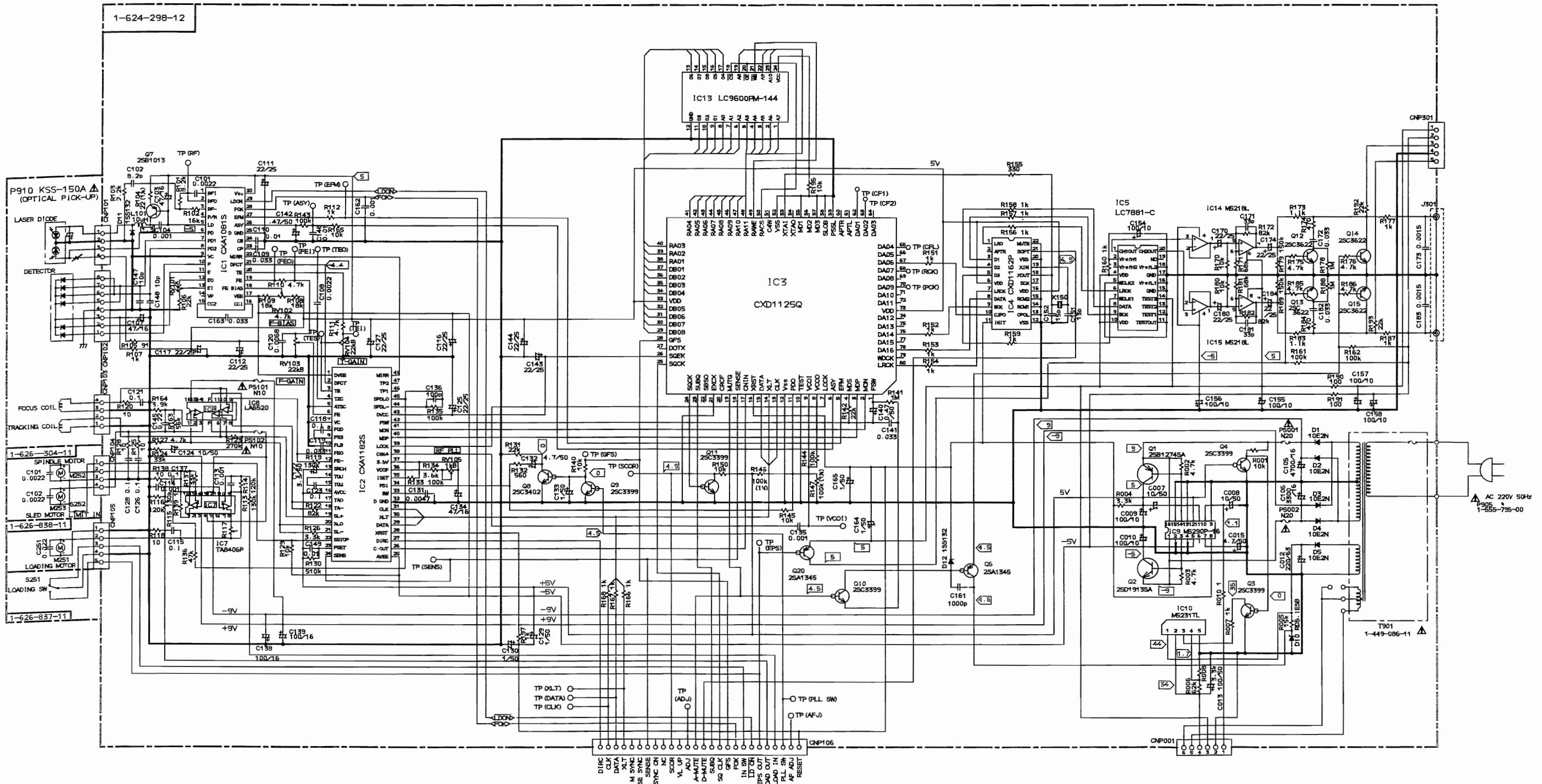
IC4 CXD1162P



IC13 LC9600PM-144



SCHEMATIC DIAGRAM



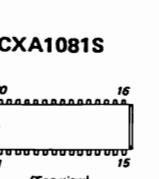
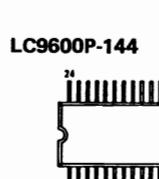
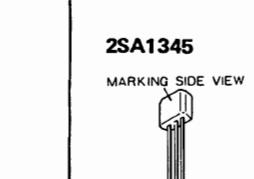
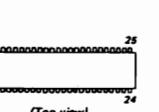
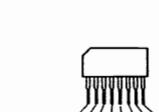
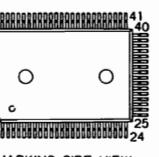
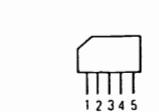
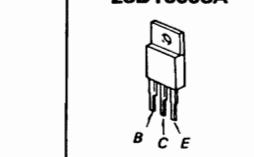
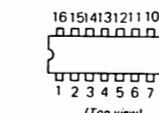
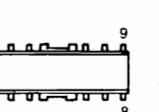
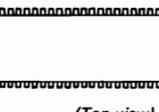
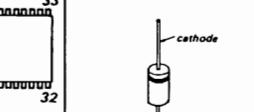
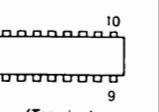
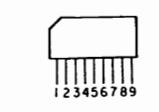
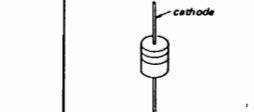
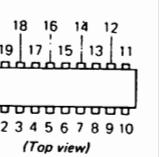
NOTES

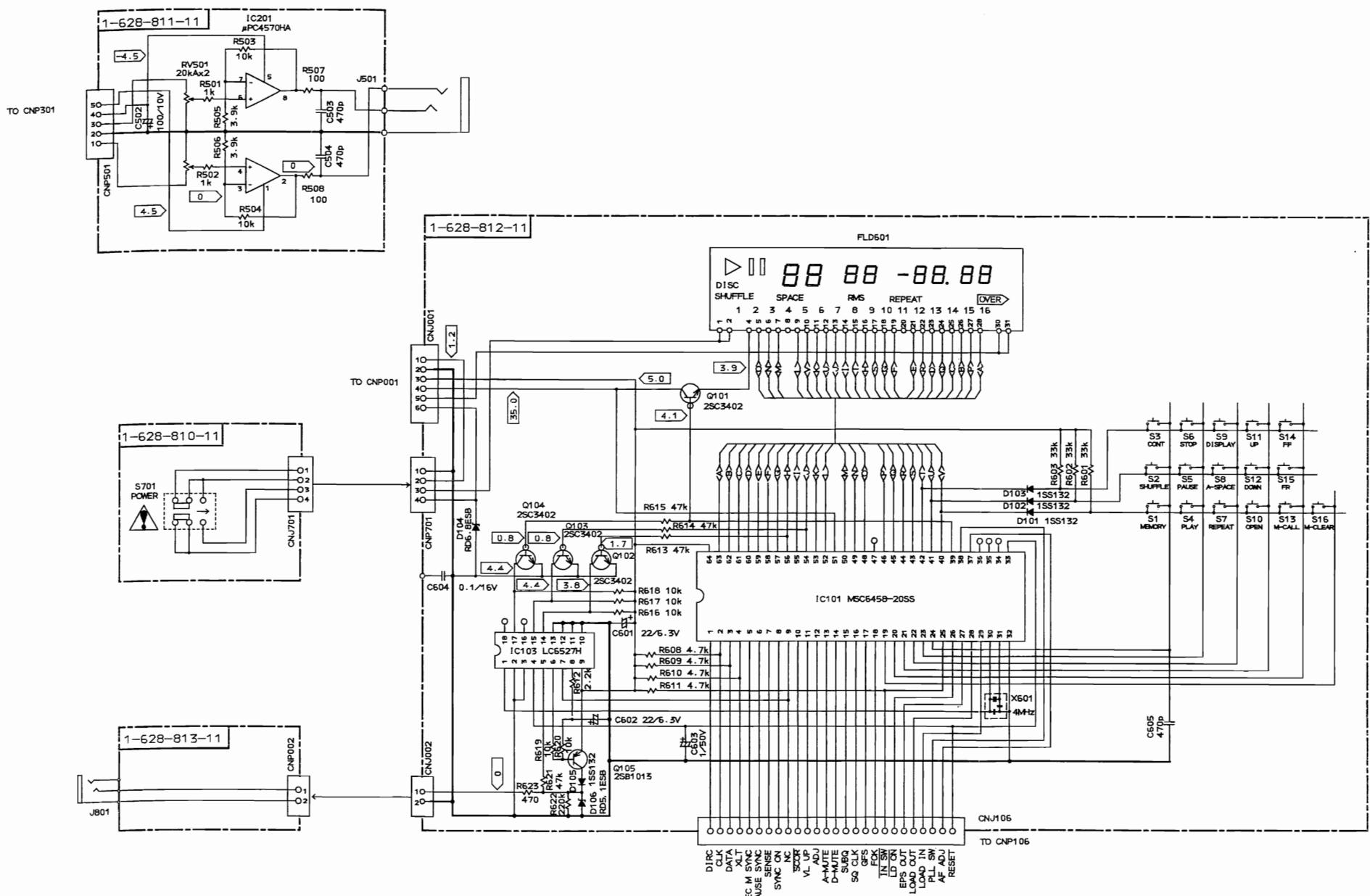
- ALL RESISTORS ARE IN OHMS, 1/4 WATT UNLESS OTHERWISE NOTED.
- ALL CAPACITORS ARE IN μF , 50V UNLESS OTHERWISE NOTED.
- ELECTROLYTIC CAPACITORS ($\text{#}\text{ }$) ARE IN $\mu\text{F}/\text{V}$.
- VOLTAGE (MEASURED WITH VTVM) (NO INPUT SIGNAL).
- CIRCUIT IS SUBJECT TO CHANGE FOR IMPROVEMENT
- THE COMPONENTS IDENTIFIED BY MARK ARE CRITICAL FOR SAFETY.
REPLACE ONLY WITH PART NUMBER SPECIFIED.

C	D	G	J	K	M	Z
$\pm 0.25\text{PF}$	$\pm 0.5\text{PF}$	$\pm 2\%$	$\pm 5\%$	$\pm 10\%$	$\pm 20\%$	$\pm \frac{80}{20}\%$

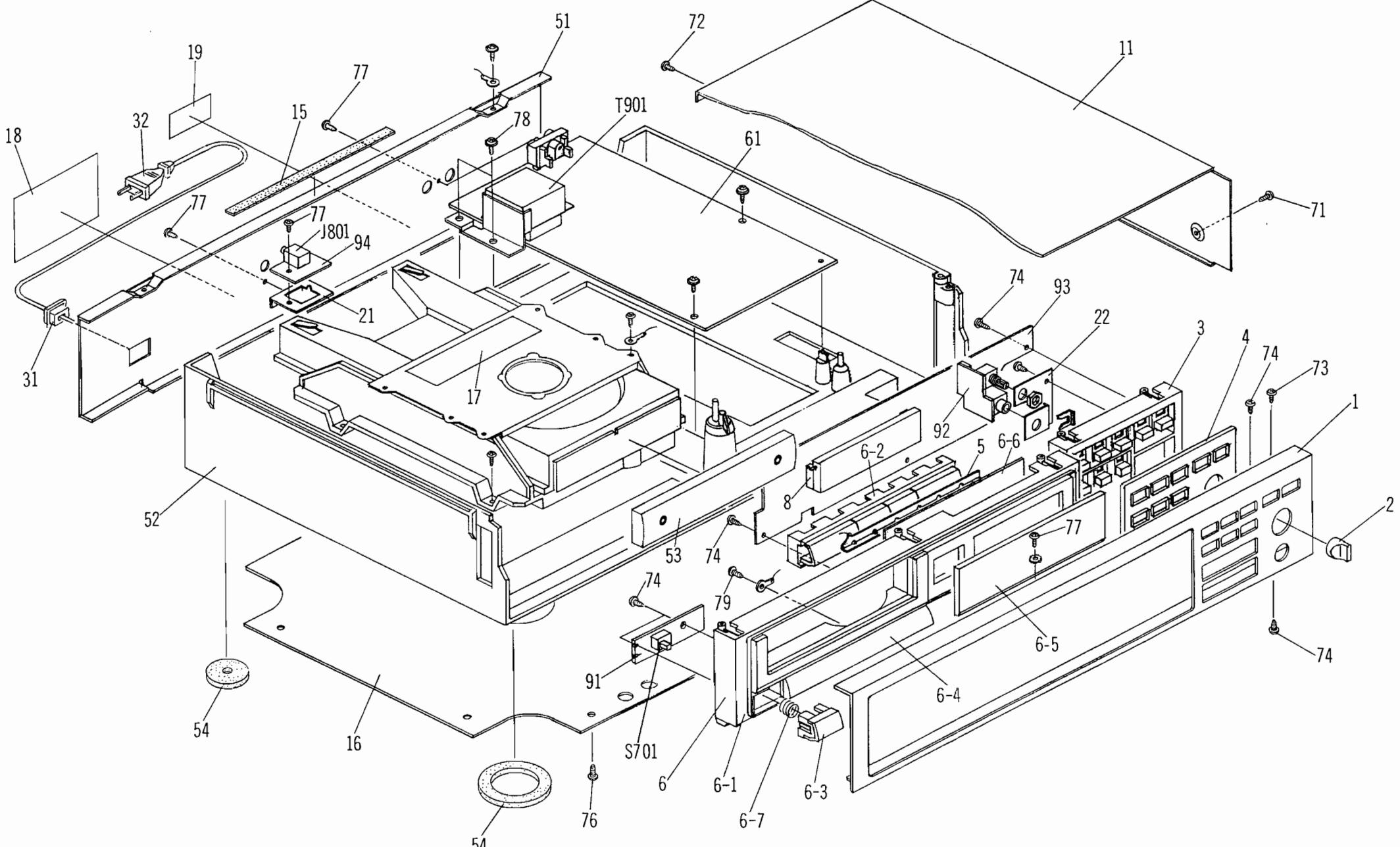
ONKYO CORPORATION

SEMICONDUCTOR LEAD LAYOUT

CXA1081S	LC9600P-144	2SA1345 MARKING SIDE VIEW
 (Top view)	 (Top view)	
CXA1182S	M5218L	2SB1013 2SC3622A-K
 (Top view)	 	
CXD1125Q	M5231TL	2SB1133SA 2SD1666SA
 MARKING SIDE VIEW	 	
CXD1162P	M5290P-16 TA8406P	2SC3399 2SC3402
 (Top view)	 (Top view)	
LA6520	MSC6458-23SS	ISS132 10E2N
 (Top view)	 	
LC6527-H	μPC4570HA	RD5.1ES-B2 RD6.8ES-B2
 (Top view)	 	
LC-7881-B		
	 (Top view)	



EXPLODED VIEW

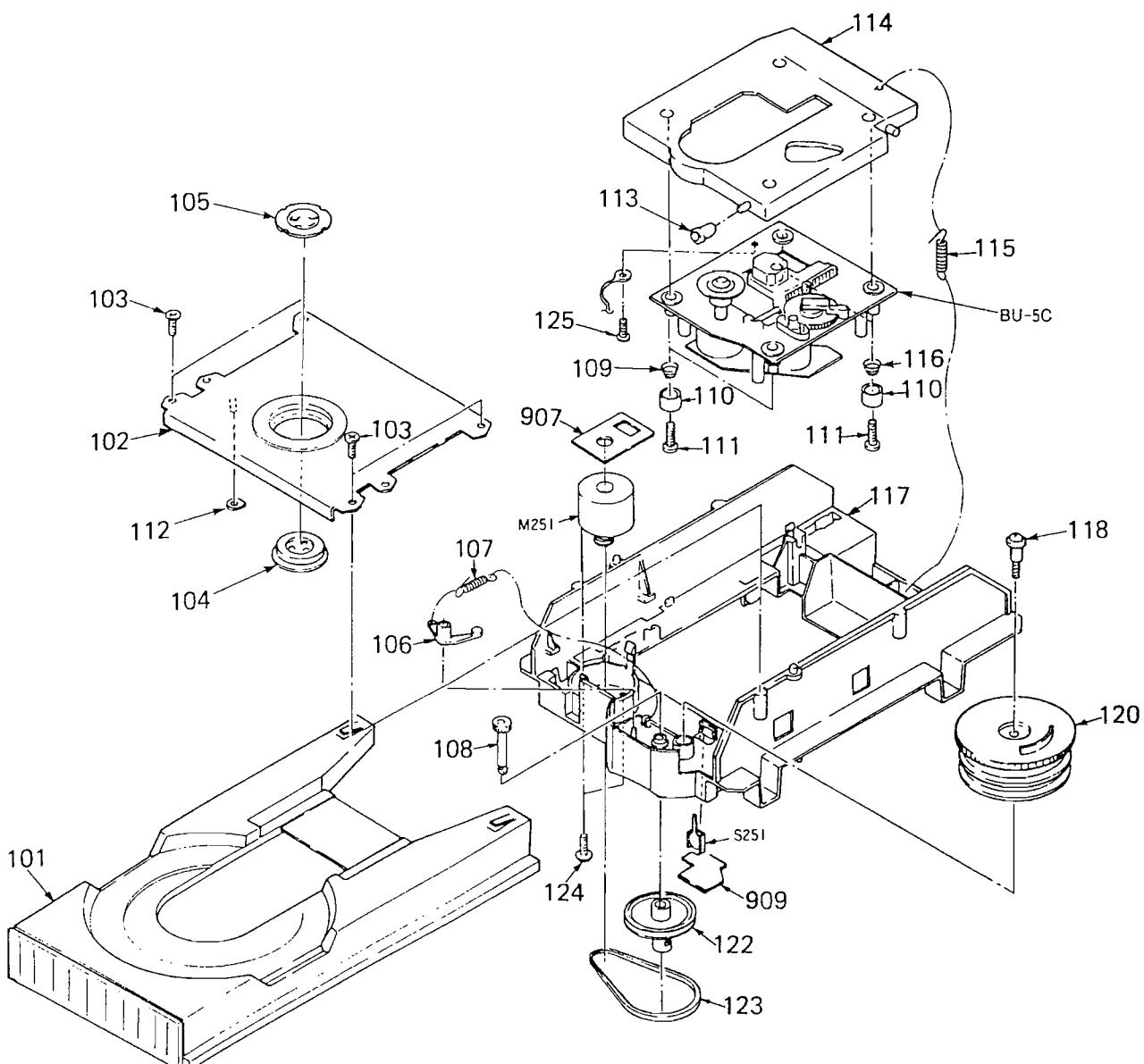


PARTS LIST

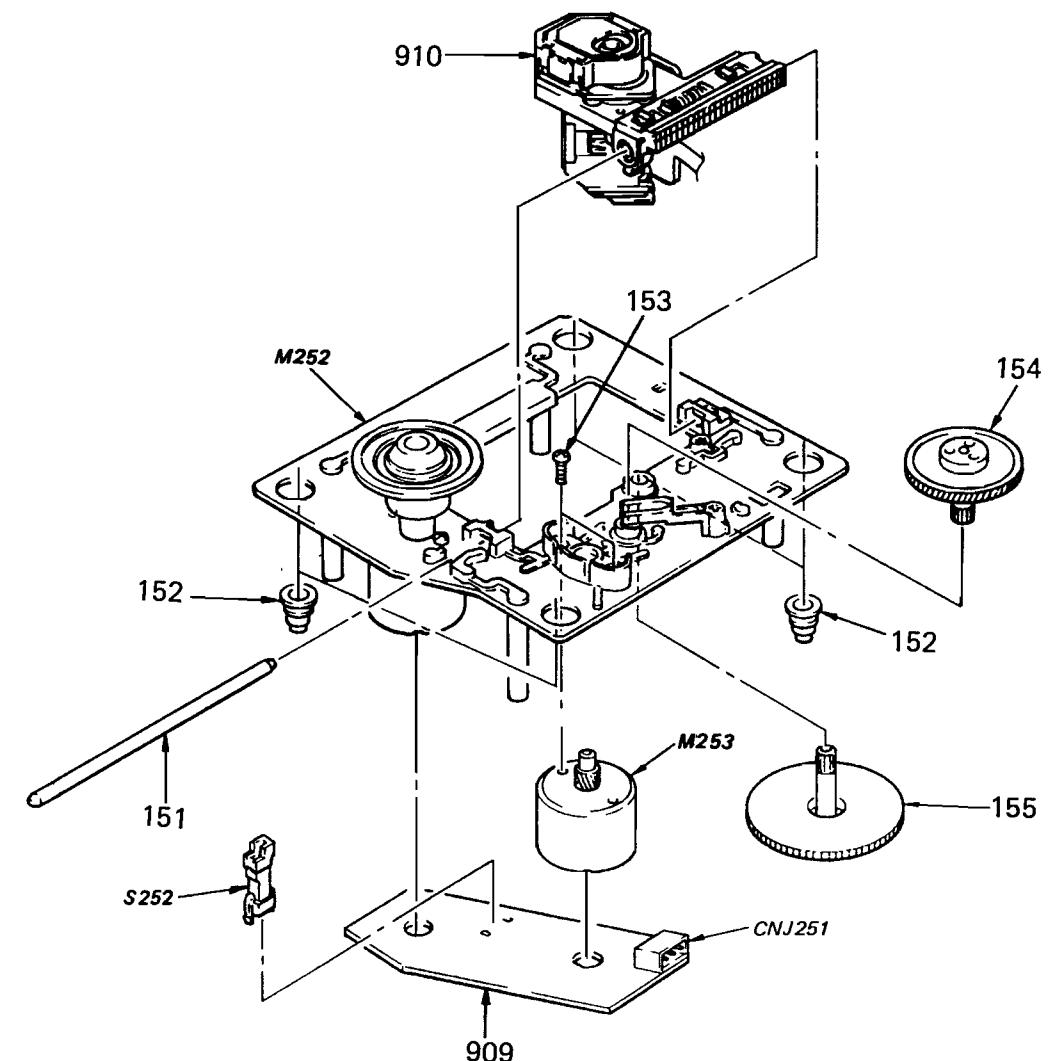
REF.NO.	PART NO.</
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MECHANISM-EXPLODED VIEW

BU-5C



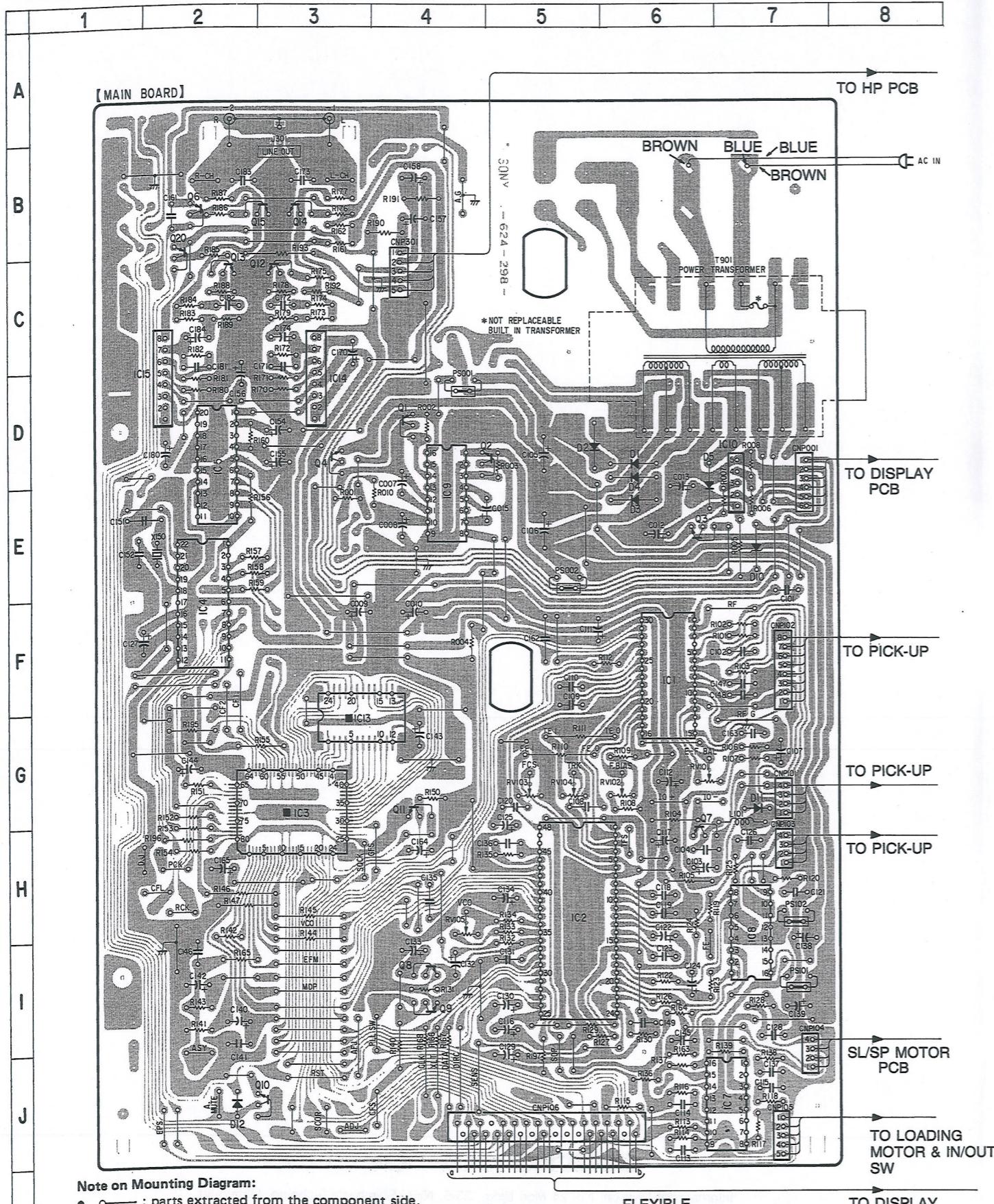
REF.NO.	PART NO.	DESCRIPTION	REF.NO.	PART NO.	DESCRIPTION
101	4-925-307-01	TABLE, DISC	115	4-917-526-01	SPRING, TENSION
102	4-922-510-01	REINFORCEMENT	116	4-917-507-01	SPRING (H)
103	7-685-546-11	SCREW, TAPPING +BTP 3×8	117	4-922-516-01	CHASSIS (MD)
		TYPE2 N-S	118	7-685-152-19	SCREW, STEP
104	A-4665-024-A	MAGNET ASSY	120	4-925-306-01	GEAR, LOADING
105	4-918-679-04	PULLEY, PRESS	122	4-922-512-01	PULLEY
106	4-917-519-01	LEVER, SET	123	4-917-522-02	BELT
107	4-917-514-01	SPRING, TENSION	124	7-621-759-40	SCREW +P SW, 2.6×6
108	4-922-508-01	GEAR(DRIVING)	125	7-621-770-67	SCREW +BVTT 2.6×6(S)
109	4-917-541-01	SPRING (B)	907	1-626-838-11	PC BOARD, LOADING
110	4-917-508-01	HOLDER, SP			MOTOR
111	7-685-535-11	SCREW +BTP 2.6×10 TYPE2	909	1-626-837-11	PC BOARD, IN/OUT SWITCH
		N-S	M251	A-4608-346-A	MOTOR ASSY, LOADING
112	4-922-529-01	DAMPER	S251	1-571-300-11	SWITCH, ROTARY (IN/OUT
113	4-917-515-01	ROLLER			SW)
114	4-922-514-01	BRACKET (BU-5)			



REF.NO.	PART NO.	DESCRIPTION
151	4-917-565-01	SHAFT, SLED
152	4-917-562-01	INSULATOR
153	7-621-255-15	SCREW +P 2×3
154	4-917-567-01	GEAR(M)
155	4-917-564-01	GEAR (P), FLATNESS
909	1-620-097-11	PC BOARD, SL/SP MOTOR
910	8-848-062-01	△ PICK-UP, OPTICAL KSS-150A (RP)
CNJ251	1-564-720-11	PIN, CONNECTOR (SMALL TYPE) 4P
M252	X-4917-523-1	BASE ASSY(including SPINDLE MOTOR)
M253	X-4917-504-1	MOTOR ASSY (SLED)
S252	1-570-822-11	SWITCH, LEAF (LIMIT IN)

The components identified by mark  are critical for safety.
Replace only with part number specified.

PRINTED CIRCUIT BOARD VIEW FROM BOTTOM SIDE



Note on Mounting Diagram:

- : parts extracted from the component side.
- : parts mounted on the conductor side.
- indicates side identified with part number.
- : Jumper wire connected to the ground pattern on
the component side.

PRINTED CIRCUIT BOARD – PARTS LIST

NOTE:

- Due to standardization, replacements (marked "#") in the parts list may be different from the parts specified in the diagrams or the components used on the set.

RESISTORS

- All resistors are in ohms.
- F: nonflammable

CIRCUIT NO.	PART NO.	DESCRIPTION	CIRCUIT NO.	PART NO.	DESCRIPTION
Transistors					
Q1	8-729-808-72	2SB1274SA	CNP106	1-566-908-11	Connector 32P
Q2	8-729-808-76	2SD1913SA	CNJ106	Film jumper	With terminal
Q3, Q4	# 8-729-900-89	DTC144ES	J301	Jacks	
Q6	# 8-729-900-61	DTA144ES	J501	1-566-921-11	Pin 2P
Q7	8-729-801-83	2SB1013	J801	1-568-151-11	Large type
Q8	# 8-729-900-80	DTC114ES	L101	1-568-150-11	Small
Q9-Q11	# 8-729-900-89	DTC144ES	S1-S16	Inductor	
Q12-Q15	8-729-107-99	2SC3622A-K	S251	1-408-563-21	10μH
Q20	# 8-729-900-61	DTA114ES	S701	Switches	
Q101-Q104	8-729-900-80	DTC114ES	X150	1-554-303-21	Key board
Q105	8-729-801-83	2SB1013	X601	1-571-300-11	Rotary
ICs					
IC1	8-752-031-80	CXA1081S	C007, C008	1-570-822-11	Leaf (Limit in)
IC2	8-752-032-33	CXA1182S	C009, C010	△ 1-571-305-11	Power
IC3	8-759-947-02	CXD1125Q	C012	Oscillators	
IC4	8-759-946-62	CXD1162P	C013	1-567-926-11	Crystal
IC5	8-759-821-23	LC7881-B	C015	1-567-686-11	Ceramic
IC7	8-759-208-96	TA8406P	C101, C102	Capacitors	
IC8	8-759-805-18	LA6520	C101	1-123-875-11	Elect. 10μF 20% 50V
IC9	8-759-630-21	M5290P-16	C102	1-124-443-00	Elect. 100μF 20% 10V
IC10	8-759-605-43	M5231TL	C103, C107	1-124-919-11	Elect. 220μF 20% 63V
IC13	# 8-752-323-64	CXK5816M-12L	C104	1-124-122-11	Elect. 100μF 20% 50V
IC14, IC15	8-759-600-02	M5218L	C105	1-124-927-11	Elect. 4.7μF 20% 50V
IC101	8-759-972-48	MSC6458-23SS	C106	1-106-351-00	Mylar 2200pF 5% 50V (Slide/Spindle motor pc board)
IC103	8-759-821-37	LC6527H-3878	C108	1-106-351-00	Mylar 2200pF 5% 50V
IC201	8-759-112-93	μPC4570HA-1	C109	1-162-198-31	Ceramic 8.2pF 10% 50V
Diodes					
D1-D5	8-719-950-59	MPG06D-6052PKG3	C110	1-162-294-31	Ceramic 47μF 20% 16V
D10	8-719-109-85	RD5.1ES-B2	C111, C112	1-124-477-11	Ceramic 1000pF 10% 50V
D11, D12	8-719-940-76	ISS132	C113, C114	1-124-887-00	Ceramic 4700μF 20% 16V
D101-D103	8-719-940-76	ISS132	C115	1-161-375-00	Ceramic 3300μF 20% 16V
D104	8-719-109-97	RD6.8ES-B2	C116, C117	1-161-329-00	Ceramic 2200pF 30% 16V
D105	8-719-940-76	ISS132	C118	1-126-233-11	Ceramic 0.033μF 5% 50V
D106	8-719-109-85	RD5.1ES-B2	C119	1-130-489-00	Mylar 0.01μF 5% 50V
Transformer, power					
T901	△ 1-449-025-11		C120	1-130-483-00	Mylar 0.001μF 10% 50V
Semi-fixed resistors			C121	1-126-233-11	Ceramic 0.1μF 20% 25V
RV101	1-228-995-00	22K, Carbon	C122	1-123-382-00	Elect. 22μF 20% 50V
RV102	1-228-993-00	4.7K, Carbon	C123	1-130-768-00	Film 3.3μF 20% 50V
RV103, RV104	1-228-995-00	22K, Carbon	C124	1-123-875-11	Elect. 0.1μF 5% 63V
RV105	1-237-953-11	1K, Metal glaze	C125, C127	1-126-233-11	Ceramic 0.0068μF 20% 16V
Variable resistor			C126, C128	1-162-851-11	Ceramic 0.001μF 20% 16V
RV501	1-237-789-11	20K/20K, Carbon	C129, C130	1-124-499-11	Elect. 0.1μF 20% 50V
IC links			C131	1-161-377-00	Ceramic 0.0047μF 30% 16V
PS001, PS002	△ 1-532-685-00		C132	1-124-927-11	Elect. 4.7μF 20% 50V
PS101, PS102	△ 1-532-605-00		C133	1-124-499-11	Elect. 1μF 20% 50V
Fluorescent indicator tube			C134	1-124-477-11	Elect. 47μF 20% 16V
FLD601	1-519-433-11		C135	1-162-294-31	Ceramic 0.001μF 10% 50V
Connector pins			C136	1-162-282-31	Ceramic 100pF 10% 50V
CN256	1-564-495-11	2P	C137	1-162-851-11	Ceramic 0.1μF 20% 16V
CN260	1-564-718-11	2P (Small type)	C138, C139	1-126-101-11	Elect. 100μF 20% 16V
CNP001	1-564-340-00	6P	C140	1-124-902-00	Elect. 0.47μF 20% 50V
CNP101	1-564-706-31	4P (Small type)	C141	1-130-489-00	Mylar 0.033μF 5% 50V
CNP102	1-564-710-11	8P (Small type)	C142	1-124-902-00	Elect. 0.47μF 20% 50V
CNP103	1-564-706-31	4P (Small type)	C143, C144	1-126-233-11	Elect. 0.47μF 20% 25V
CNP104	1-564-706-11	4P (Small type)			
CNP105	1-564-339-61	5P			
CNP301	1-564-707-11	5P (Small type)			
CNP501	1-564-721-11	5P (Small type)			
CNP601	1-564-497-11	4P			

The components identified by mark  are critical for safety.
Replace only with part number specified.

CIRCUIT NO.	PART NO.	DESCRIPTION	CIRCUIT NO.	PART NO.	DESCRIPTION
C145	1-130-772-00	Film 0.22μF 5% 63V	R142	1-249-433-11	Carbon 22k 5% 1/4W
C146	1-130-483-00	Mylar 0.01μF 5% 50V	R143, R144	1-249-441-11	Carbon 100k 5% 1/4W
C147, C148	1-162-199-31	Ceramic 10pF 5% 50V	R145, R150	1-249-429-11	Carbon 10k 5% 1/4W
C149	1-161-379-00	Ceramic 0.01μF 20% 16V	R146, R147	1-215-469-00	Metal 100k 1% 1/6W
C151	1-162-202-31	Ceramic 13pF 5% 50V	R151-R154	1-249-417-11	Carbon 1k 5% 1/4W
C152	1-162-203-31	Ceramic 15pF 5% 50V	R155	1-249-411-11	Carbon 330ohm 5% 1/4W
C154-C158	1-124-443-00	Elect. 100μF 20% 10V	R156-R160	1-249-417-11	Carbon 1k 5% 1/4W
C161	1-161-379-00	Ceramic 0.01μF 20% 16V	R161, R162	1-249-441-11	Carbon 100k 5% 1/4W
C162	1-162-294-31	Ceramic 0.001μF 10% 50V	R163	1-249-438-11	Carbon 56k 5% 1/4W
C163	1-130-489-00	Mylar 0.033μF 5% 50V	R164	1-249-424-11	Carbon 3.9k 5% 1/4W
C164, C165	1-124-499-11	Elect. 1μF 20% 50V	R165, R170	1-249-429-11	Carbon 10k 5% 1/4W
C170	1-126-233-11	Elect. 22μF 20% 25V	R166-R168	1-249-417-11	Carbon 1k 5% 1/4W
C171	1-162-211-31	Ceramic 33pF 5% 50V	R171	1-249-439-11	Carbon 68k 5% 1/4W
C172	1-130-489-00	Mylar 0.033μF 5% 50V	R172	1-249-440-11	Carbon 82k 5% 1/4W
C173	1-106-347-00	Mylar 0.0015μF 5% 50V	R173	1-247-832-11	Carbon 1.1k 5% 1/4W
C174, C180	1-126-233-11	Elect. 22μF 20% 25V	R174	1-249-413-11	Carbon 470ohm 5% 1/4W
C181	1-162-211-31	Ceramic 33pF 5% 50V	R175, R176	1-249-425-11	Carbon 4.7k 5% 1/4W
C182	1-130-489-00	Mylar 0.033μF 5% 50V	R177	1-249-417-11	Carbon 1k 5% 1/4W
C183	1-106-347-00	Mylar 0.0015μF 5% 50V	R178	1-247-903-00	Carbon 1M 5% 1/4W
C184	1-126-233-11	Elect. 22μF 20% 25V	R179	1-247-883-00	Carbon 150k 5% 1/4W
C251	1-136-157-00	Film 0.022μF 5% 50V	R180	1-249-429-11	Carbon 10k 5% 1/4W
C502	1-124-443-00	Elect. 100μF 20% 10V	R181	1-249-439-11	Carbon 68k 5% 1/4W
C503, C504	1-162-290-31	Ceramic 470pF 10% 50V	R182	1-249-440-11	Carbon 82k 5% 1/4W
C601, C602	1-124-638-11	Elect. 22μF 20% 6.3V	R183	1-247-832-11	Carbon 1.1k 5% 1/4W
C603	1-124-438-00	Elect. 1μF 20% 50V	R184	1-249-413-11	Carbon 470ohm 5% 1/4W
C604	1-162-851-11	Ceramic 0.1μF 20% 16V	R185, R186	1-249-425-11	Carbon 4.7k 5% 1/4W
C605	1-162-290-31	Ceramic 470pF 10% 50V	R187	1-249-417-11	Carbon 1k 5% 1/4W
Resistors					
R001	1-249-429-11	Carbon 10k 5% 1/4W	R188	1-247-903-00	Carbon 1M 5% 1/4W
R002, R003	1-249-425-11	Carbon 4.7k 5% 1/4W	R189	1-247-883-00	Carbon 150k 5% 1/4W
R004	1-249-423-11	Carbon 3.3k 5% 1/4W	R190, R191	1-249-405-11	Carbon 100ohm 5% 1/4W
R005	1-249-431-11	Carbon 15k 5% 1/4W	R192, R193	1-249-433-11	Carbon 22k 5% 1/4W
R006	1-247-874-11	Carbon 62k 5% 1/4W	R195	1-249-429-11	Carbon 10k 5% 1/4W
R007	1-249-417-11	Carbon 1k 5% 1/4W	R197, 501, 502	1-249-417-11	Carbon 1k 5% 1/4W
R008	1-249-423-11	Carbon 3.3k 5% 1/4W	R198, R504	1-249-429-11	Carbon 10k 5% 1/4W
R010	1-249-381-11	Carbon 1ohm 5% 1/4W	R199, R505, R506	1-249-424-11	Carbon 3.9k 5% 1/4W
R101	1-249-428-11	Carbon 8.2k 5% 1/4W	R200, R507, R508	1-249-405-11	Carbon 100ohm 5% 1/4W
R102	1-247-860-11	Carbon 16k 5% 1/4W	R201, R603	1-249-435-11	Carbon 33k 5% 1/4W
R103	1-249-421-11	Carbon 2.2k 5% 1/4W	R202, R608-R611	1-249-425-11	Carbon 4.7k 5% 1/4W
R104	1-215-381-00	Metal 22ohm 1% 1/6W	R203, R612	1-249-421-11	Carbon 2.2k 5% 1/4W
R105	1-247-806-11	Carbon 91ohm 5% 1/4W	R204, R613-R615	1-249-437-11	Carbon 47k 5% 1/4W
R106	1-249-433-11	Carbon 22k 5% 1/4W	R205, R619-R620	1-249-429-11	Carbon 10k 5% 1/4W
R107, R112	1-249-417-11	Carbon 1k 5% 1/4W	R206, R621	1-249-437-11	Carbon 47k 5% 1/4W
R108, R109	1-249-432-11	Carbon 18k 5% 1/4W	R207, R622	1-247-887-00	Carbon 220k 5% 1/4W
R110, R111	1-249-425-11	Carbon 4.7k 5% 1/4W	R208, R623	1-249-413-11	Carbon 470ohm 5% 1/4W
R113, R115	1-247-882-11	Carbon 130k 5% 1/4W			
R114, R116	1-247-881-00	Carbon 120k 5% 1/4W			
R117	1-249-381-11	Carbon 1ohm 5% 1/4W			
R118, R120	1-249-393-11	Carbon 10ohm 5% 1/4W			
R119	1-247-882-11	Carbon 130k 5% 1/4W			
R122	1-249-440-11	Carbon 82k 5% 1/4W			
R123	1-247-889-00	Carbon 270k 5% 1/4W			
R124	1-249-435-11	Carbon 33k 5% 1/4W			
R125, R128	1-249-393-11	Carbon 10ohm 5% 1/4W			
R126	1-249-423-11	Carbon 3.3k 5% 1/4W			
R127	1-249-425-11	Carbon 4.7k 5% 1/4W			
R129	1-249-429-11	Carbon 10k 5% 1/4W			
R130	1-247-896-11	Carbon 510k 5% 1/4W			
R131	1-249-433-11	Carbon 22k 5% 1/4W			
R132	1-249-414-11	Carbon 560ohm 5% 1/4W			
R133	1-249-441-11	Carbon 100k 5% 1/4W			
R134	1-215-434-00	Metal 3.6k 1% 1/6W			
R135	1-249-441-11	Carbon 100k 5% 1/4W			
R136	1-249-437-11	Carbon 47k 5% 1/4W			
R137	1-249-435-11	Carbon 33k 5% 1/4W			
R138	1-249-393-11	Carbon 10ohm 5% 1/4W			
R139	1-249-381-11	Carbon 1ohm 5% 1/4W			
R140	1-249-429-11	Carbon 10k 5% 1/4W			
R141	1-247-903-00	Carbon 1M 5% 1/4W			

ACCESSORY & PACKING MATERIAL

PART NO.	DESCRIPTION
4-922-466-01	Cushion (Pad)
4-922-465-11	Individual carton (Black model)
4-922-465-21	Individual carton (Silver model)
3-786-841-41	Manual, instruction
1-558-543-11	Cord, connection
1-574-408-11	Cord, connection (RI)
3-701-630-01	Polyethylene bag
4-922-467-01	Serial sheet
4-922-470-01	Polyethylene bag for warranty card
4-922-469-01	Warranty card
3-704-346-01	Sheet, protection

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